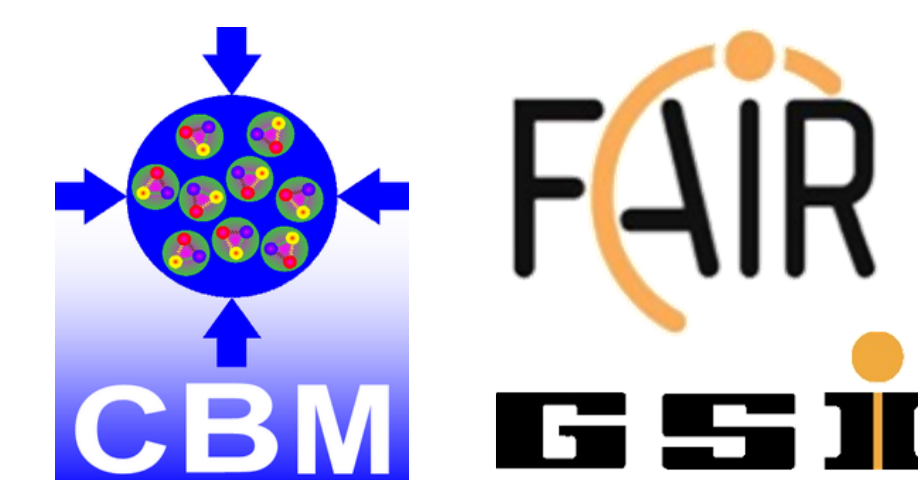


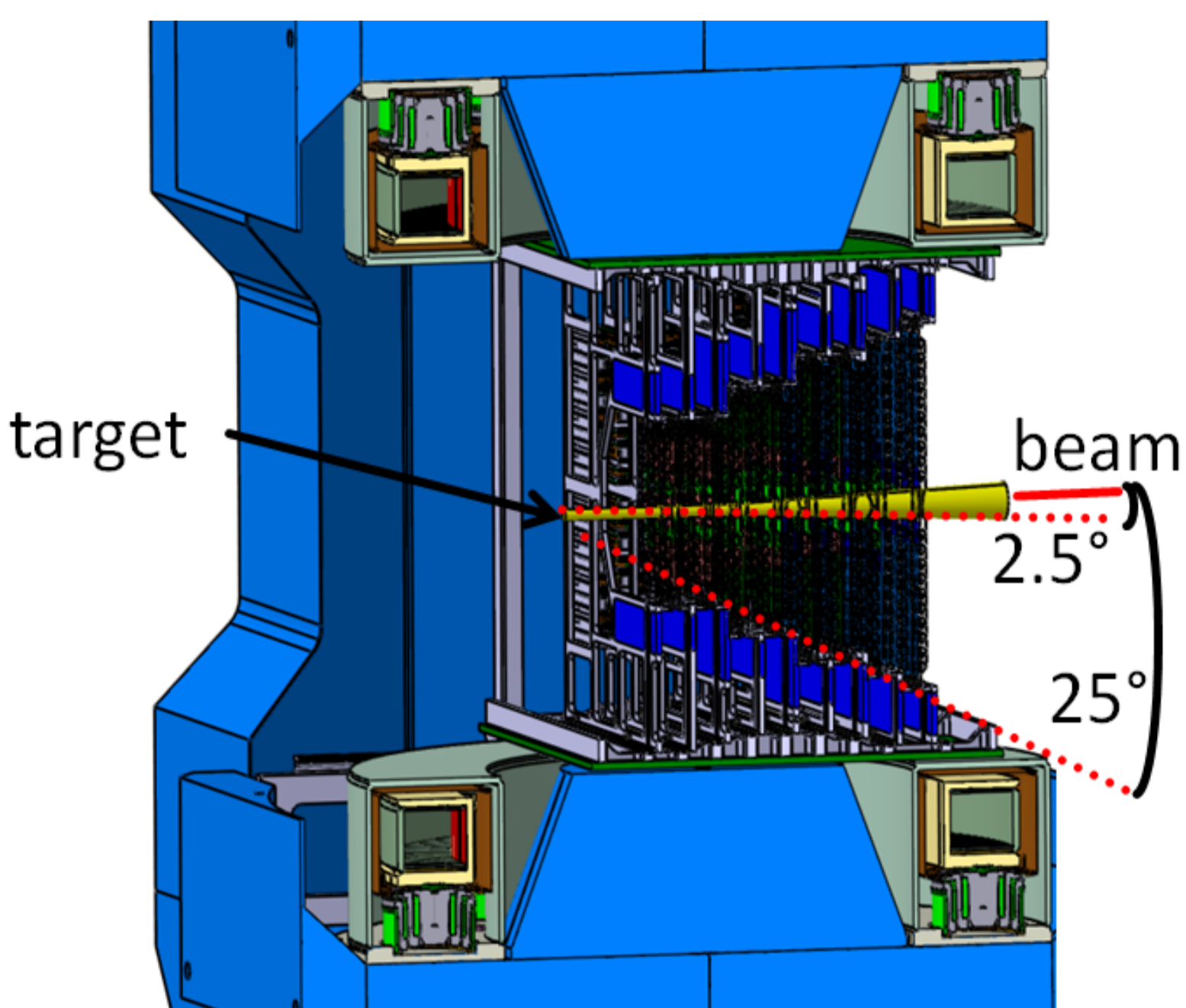
THE SILICON TRACKING SYSTEM OF CBM

GETTING READY FOR EXPERIMENT



Adrian Rodríguez Rodríguez^{1,2} for the CBM Collaboration

STS for the CBM experiment



- track point measurement in high-rate collision environment:
 - $10^5 - 10^7/s$ (A+A), up to $10^9/s$ (p+A)
- physics aperture : $2.5^\circ \leq \theta \leq 25^\circ$
- 8 tracking stations built with double-sided silicon microstrip sensors
- self-triggering front-end electronics
- material : $\approx 0.4\% - 1.4\% X_0$ per station
- hit spatial resolution $\approx 25 \mu m$
- $\Delta p/p \approx 1.8\%$ ($p > 1 \text{ GeV}/c$, 1 Tm field)
- track ($> 1 \text{ GeV}/c$) and single hit reconstruction efficiency 96% and 98%

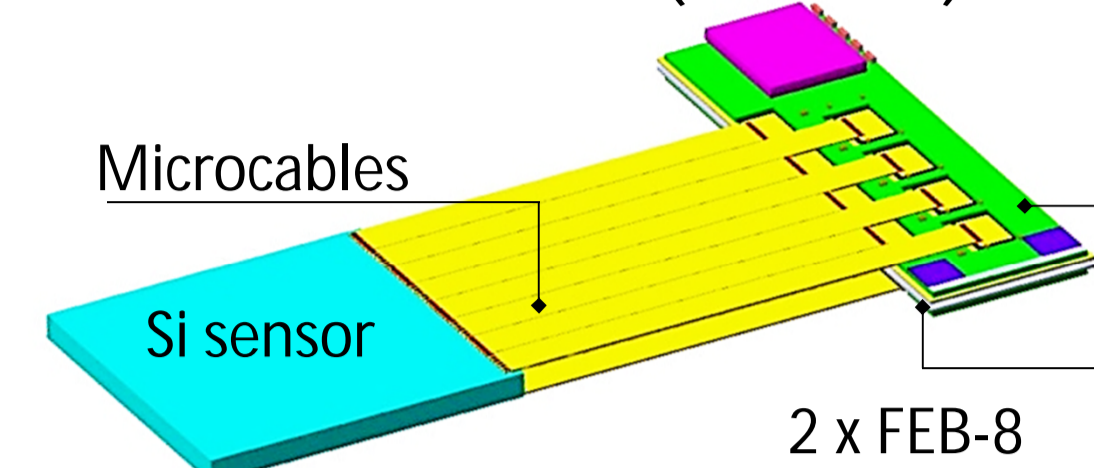
Silicon sensors and detector module

Double-sided n-type silicon sensors

- Thickness: $\sim 300 \mu m$
- 58 μm pitch
- 1024 strips/side
- strip length 2/4/6/12 cm
- 7.5° stereo angle for p-side strips (suppression of the ghost track rate)
- double-metal routing on p-side
- radiation tolerance:
 - $1 \times 10^{14} n_{eq}$ (1 MeV) / cm^2 , 1 Mrad
- prototypes developed and produced: CiS/Germany and Hamamatsu/Japan

Detector module as functional unit:

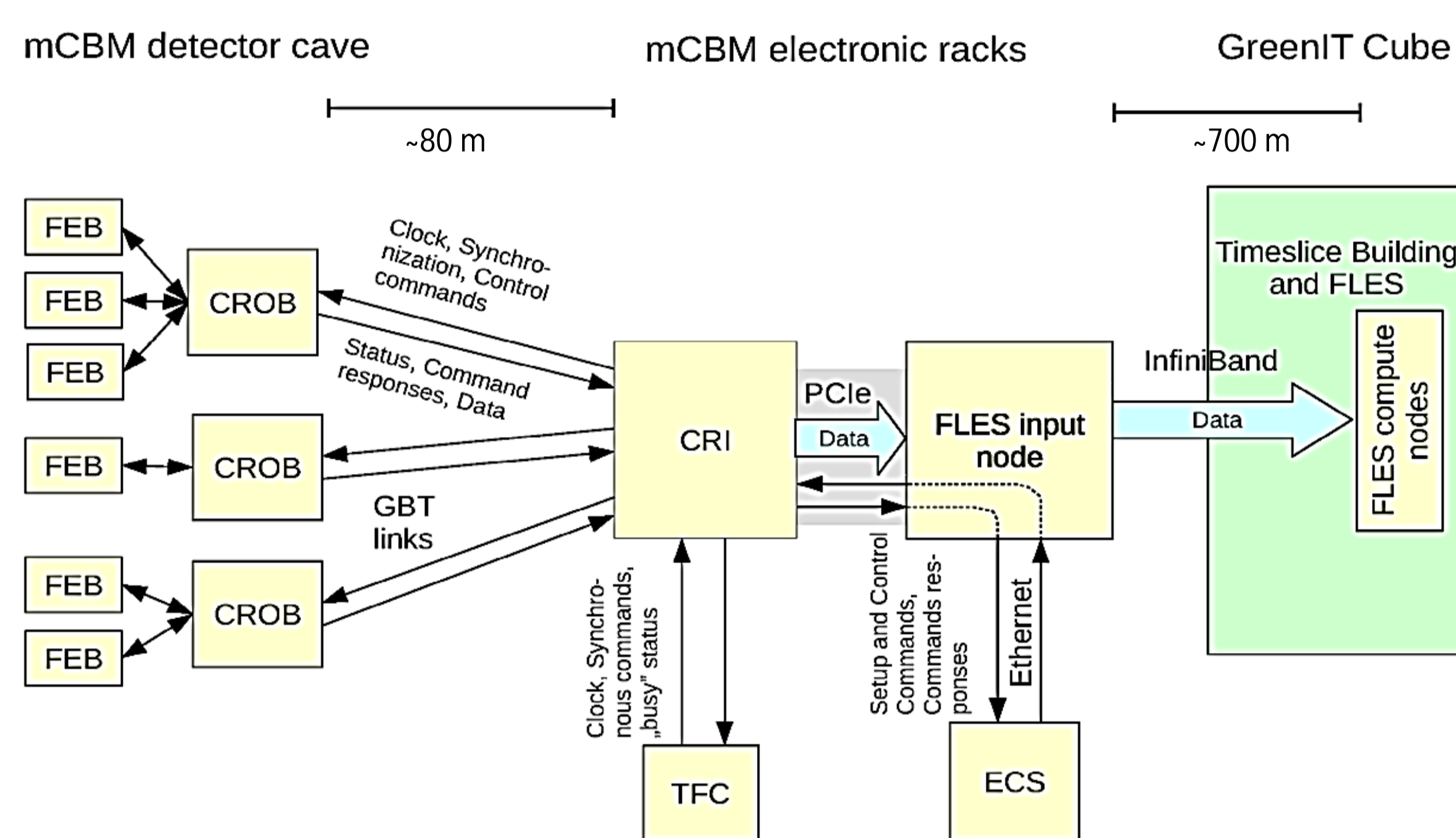
- silicon sensor
- stack of polyamide readout cables
- 2 front-end boards (16 ASICs)



STS detector in numbers:

- 896 detector modules
- 106 ladders
- 1.6 million channels

Readout chain



Block diagram of the STS readout chain

High performance, free-streaming readout chain

Main components:

FEB: Front-end boards

ROB: Readout board

CRI: Common readout interface

TFC: Timing and fast control

ECS: Experiment control system

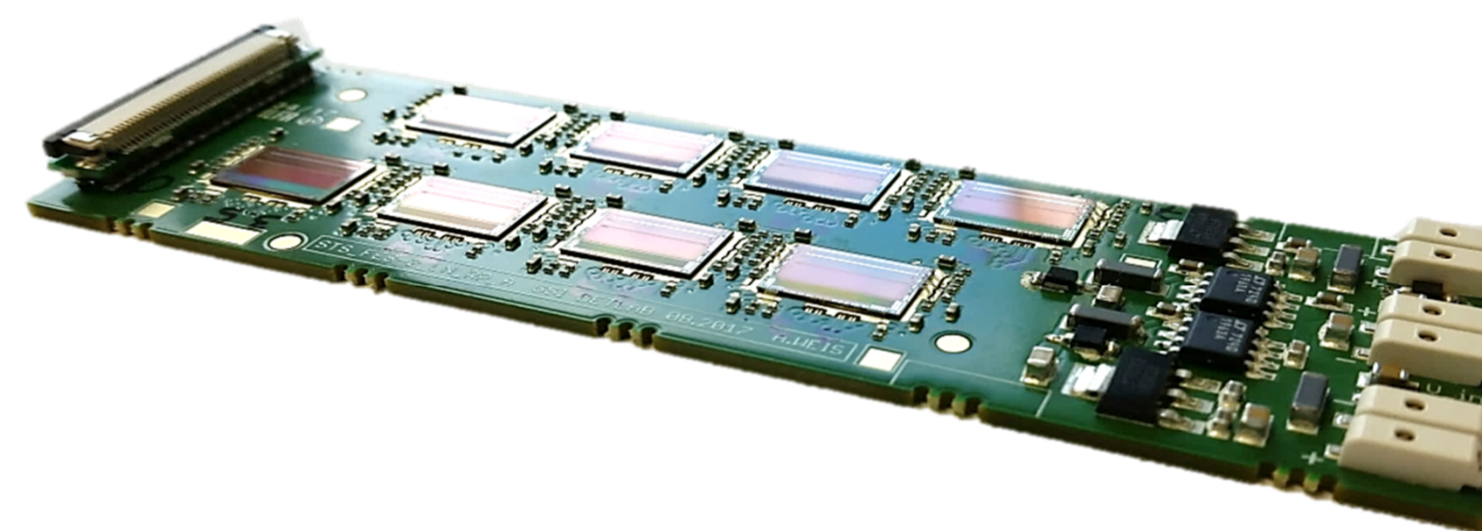
FLES: First level event selector

Front-end electronics

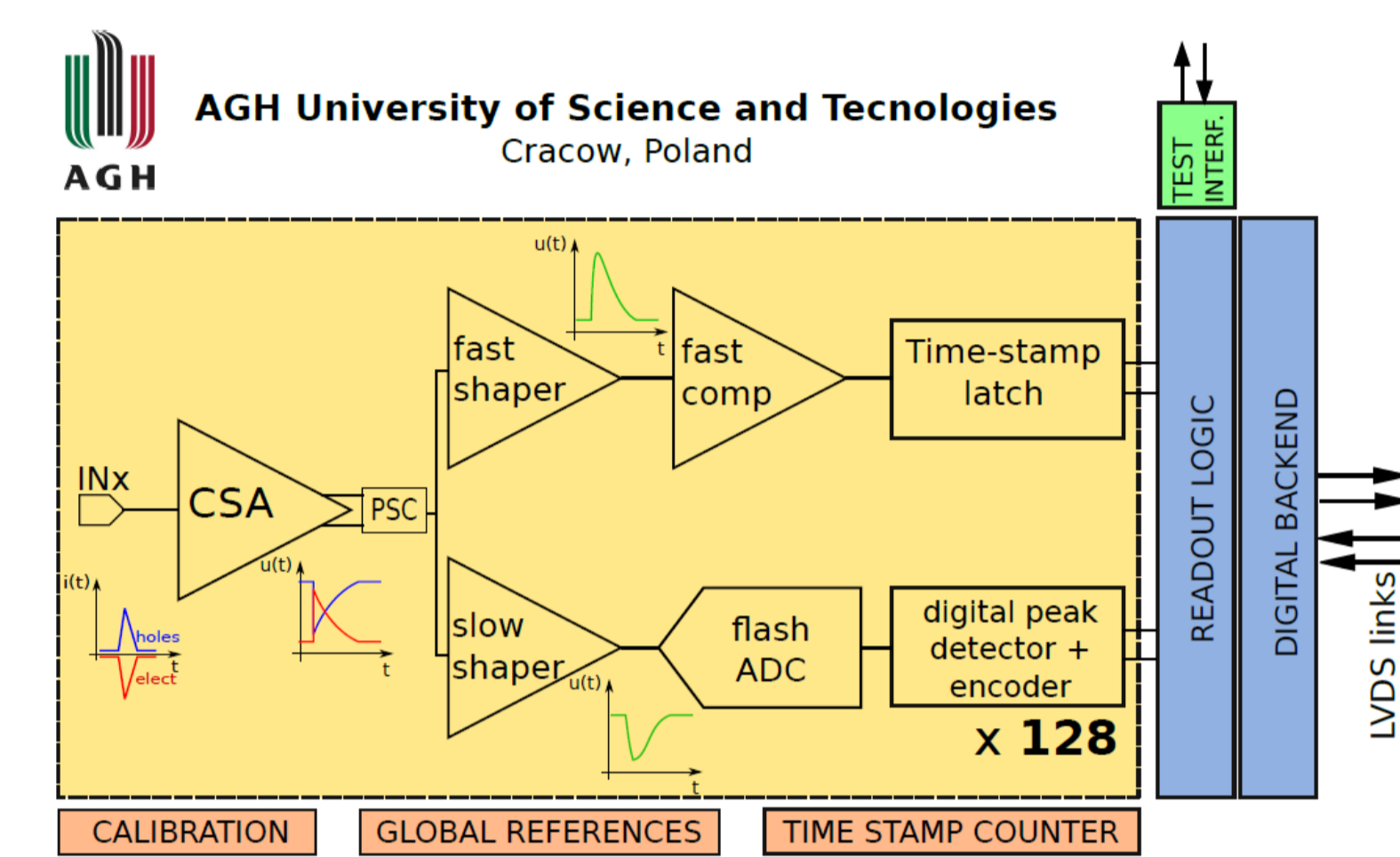
STS-XYTER ASIC

STS + X, Y coordinates + Time and Energy Resolution

- 128 readout channels + 2 test channels
- expected total capacitance: Up to 40 pF
- both signals polarity
- time resolution $< 5 \text{ ns}$
- 5 bit flash ADC/channel (15 fC dynamic range)
- hit rate/channel: $> 250 \text{ kHz}$
- radiation hard layout
- digital backend compatible with the CERN-GBTx data concentrator



Prototype of the STS front-end board carrying 8 STS-XYTER ASICs

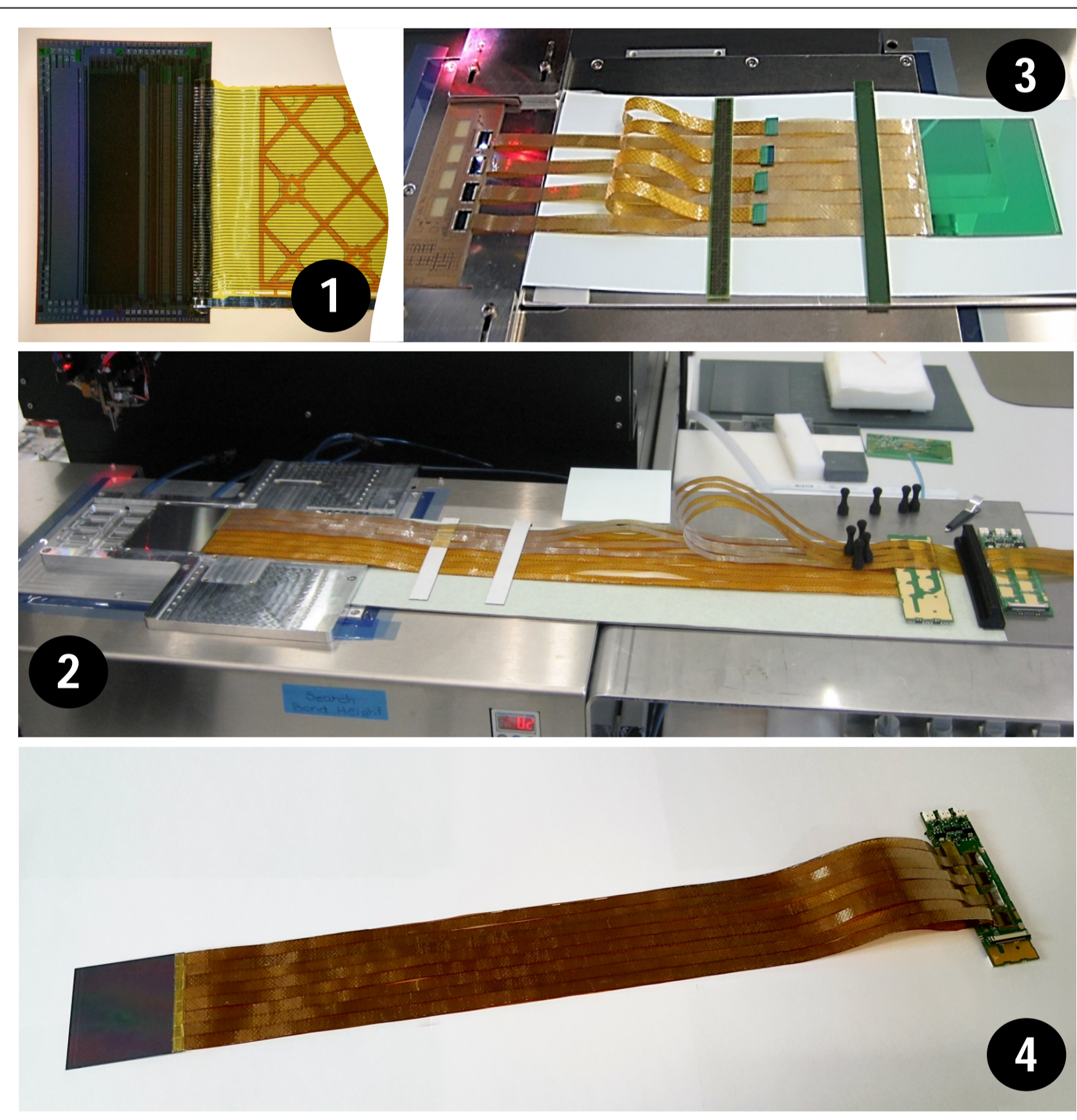


Block diagram of the STS-XYTER ASIC

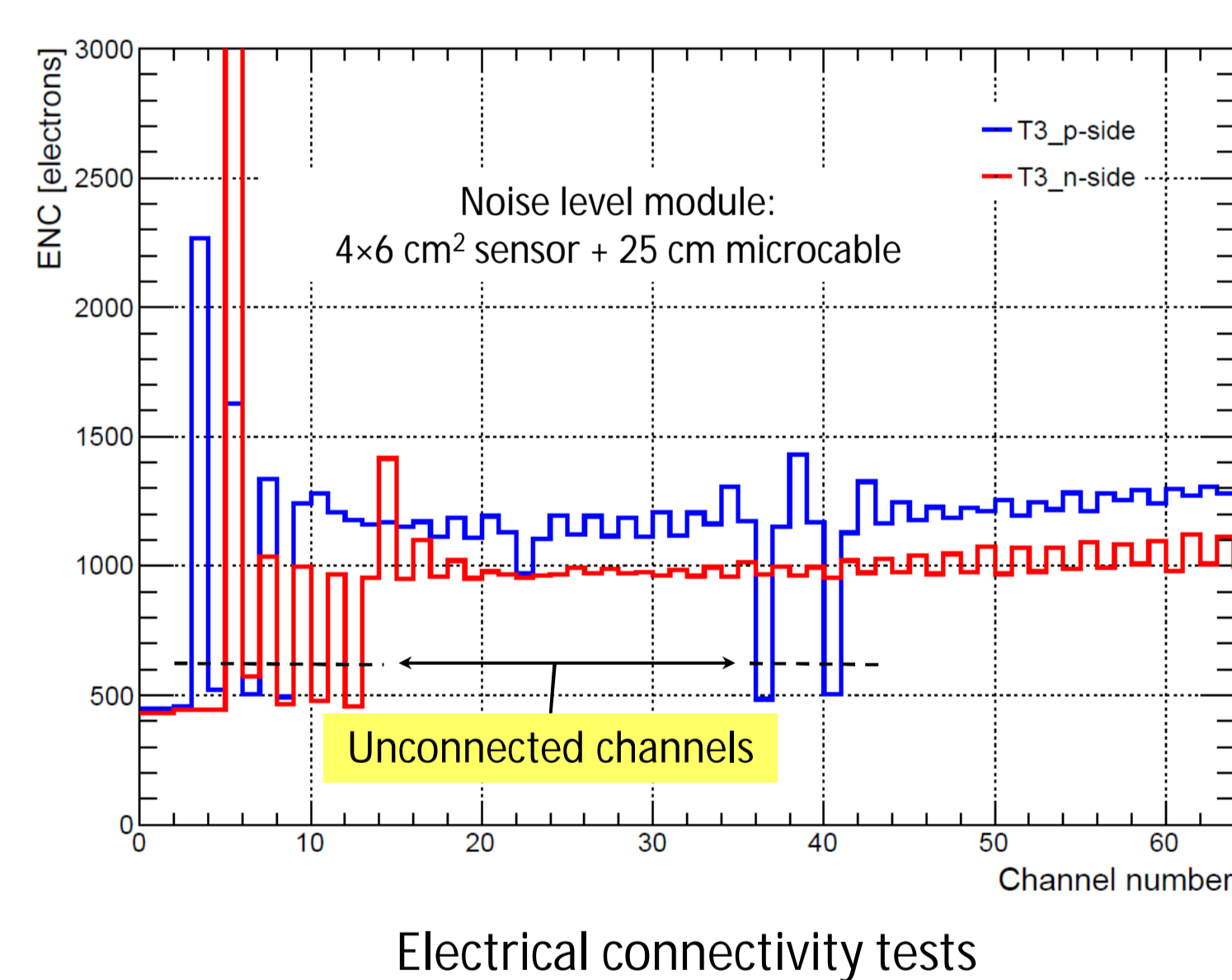
Front-end Board

- part of a functional module
- high-level integration board with 8 STS-XYTER ASICs and up to 5 data links per ASIC
- connected via microcables to the Si sensors

Module assembly

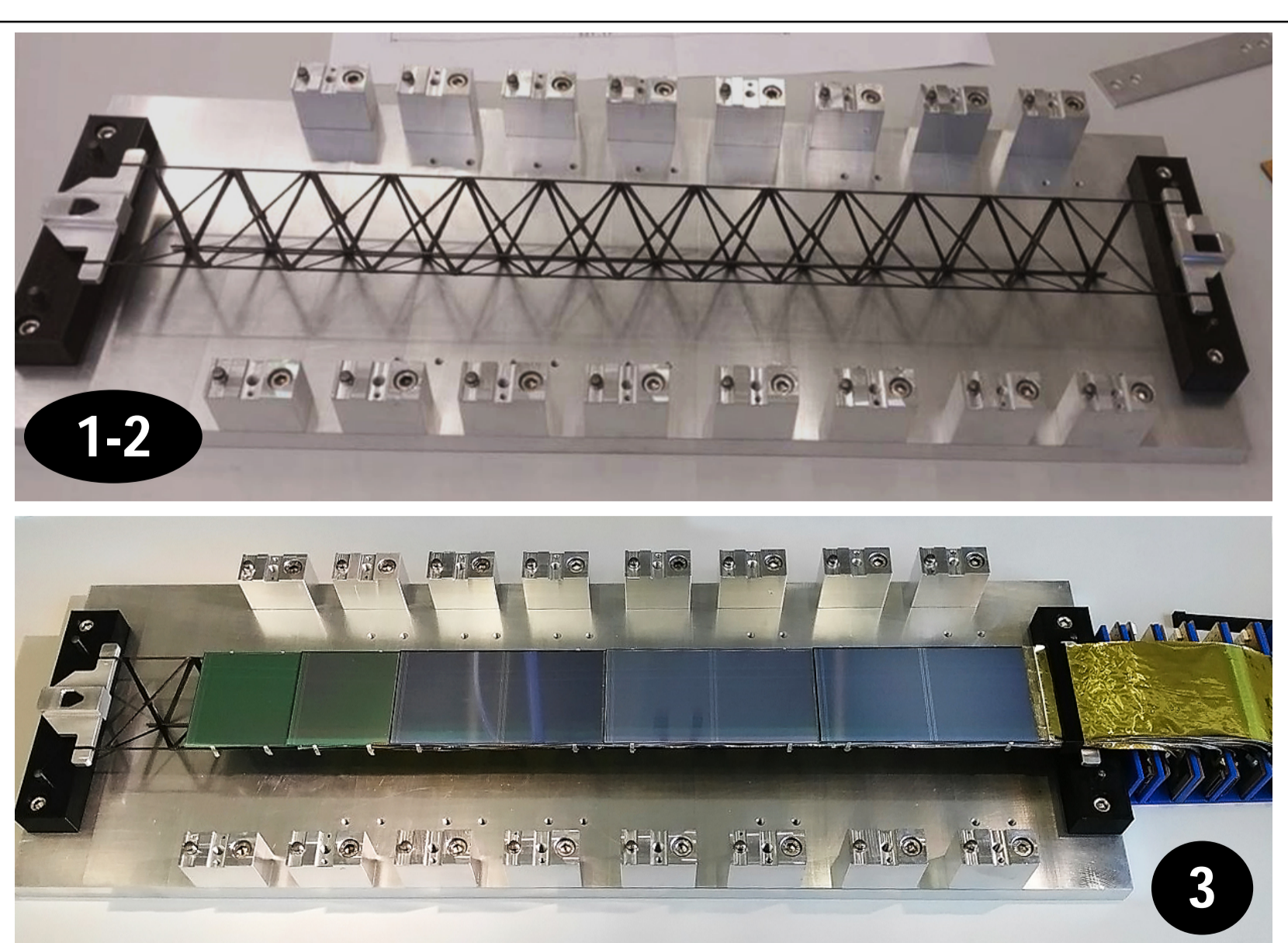


- STEP_1:** tab-bonding microcables to ASICs
- STEP_2:** tab-bonding microcables to Si-sensor
- STEP_3:** die and wirebonding ASICs to the FEB-8
- STEP_4:** gluing of shielding layers and spacers



Electrical connectivity tests

Ladder assembly



- STEP_1:** gluing support structures for sensor holding
- STEP_2:** mounting modules onto low-mass carbon-fiber support
- STEP_3:** semi-automated optical survey for monitoring sensor position (10 μm precision)
- STEP_4:** ladder transfer to mounting frame (See mSTS fig.)

CBM full test setup for high rate, nucleus-nucleus collisions at GSI/FAIR SIS18

GOALS:

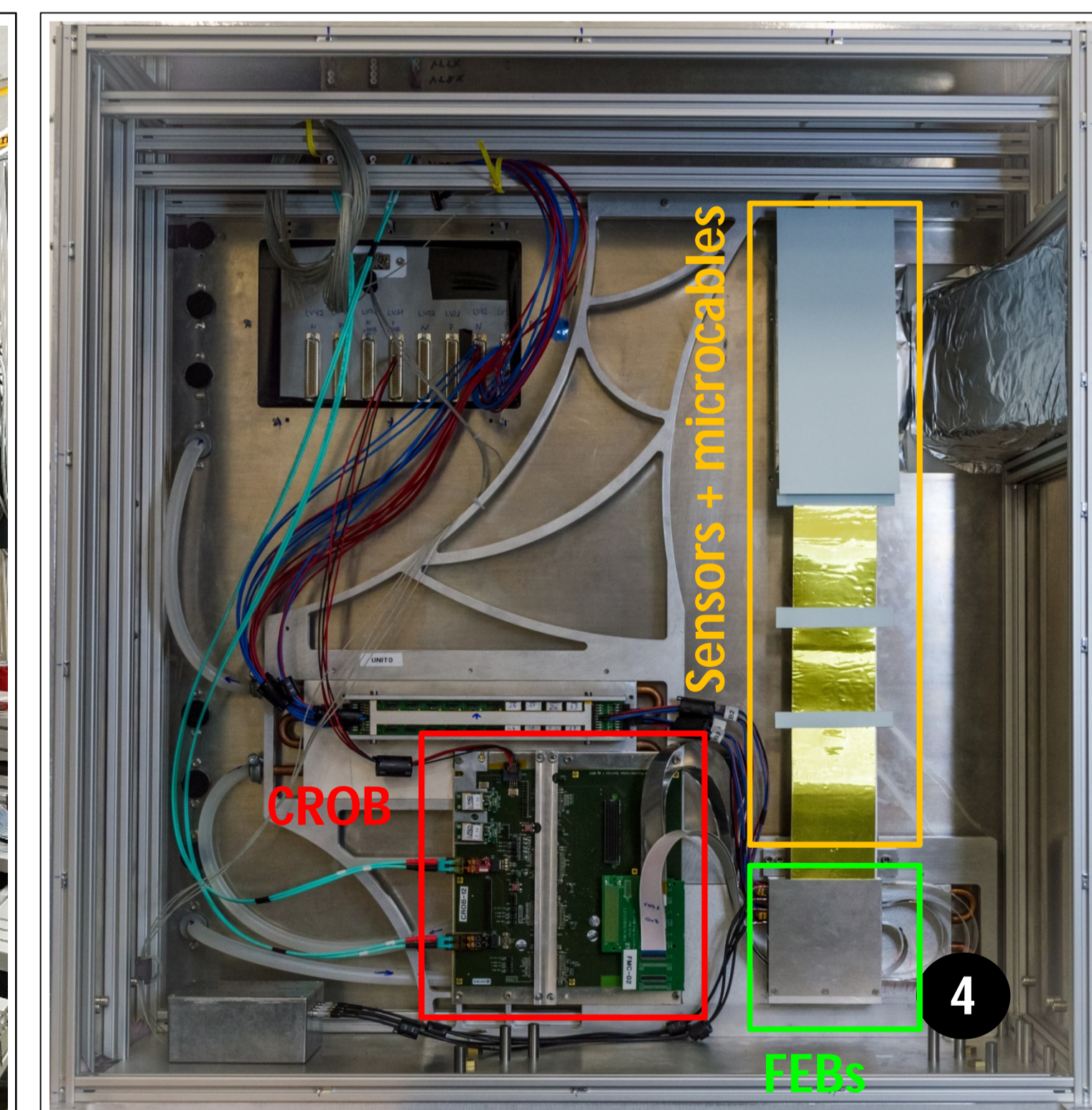
- demonstrator for full CBM data taking and analysis
- integrating prototype detector's modules into a common, free-streaming DAQ
- reconstructing physics observable (Λ reconstruction using Ni-Ni at 1.93 AGeV and Au+Au at 1.54 AGeV)

STS getting ready (mSTS)

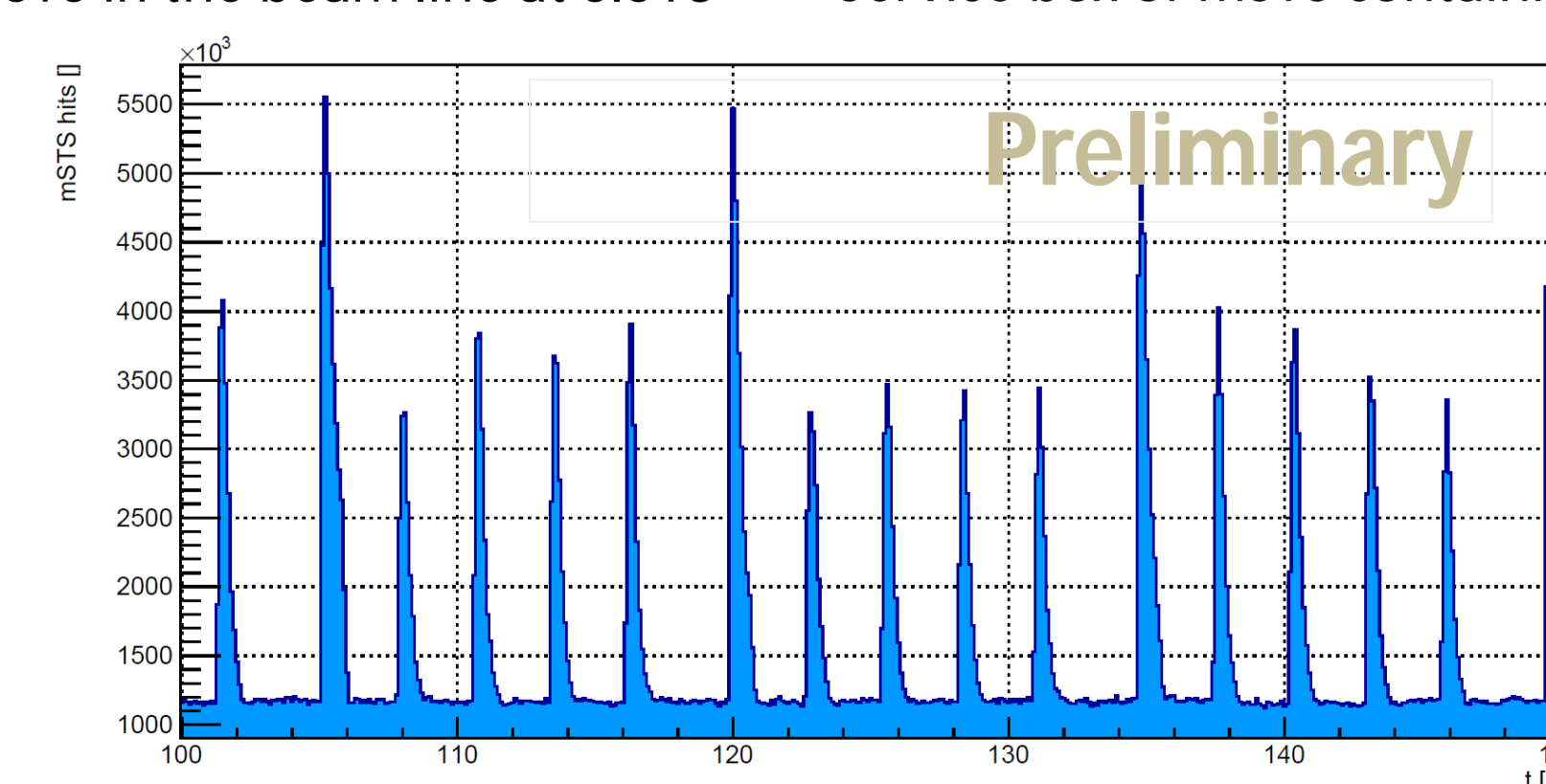
- operation of full STS modules in real data taking scenario
- 13 STS sensor modules grouped in 2 tracking stations (5 ladders)
- 208 STS-XYTER ASICs (~26600 readout channels)
- December 2018: first detector ladder with 2 modules installed



Installation of mSTS in the beam line at SIS18



Service box of mSTS containing 1/2 station built with 2 modules



Beam spill structure monitored in mSTS modules during commissioning runs

STS project:

Key participant institutes:

GSI (Darmstadt, Germany), JINR (Dubna, Russia), Univ. Tübingen (Germany), KIT (Karlsruhe, Germany), AGH (Krakow, Poland), JU (Krakow, Poland), WUT (Warsaw, Poland)

Timeline:

- Production Readiness: Jun. 2019
 - Detector construction: 2019 – 2024
- Assembly Centers: GSI-FAIR, JINR-VBLHEP

- Goethe Universität Frankfurt am Main
- GSI Helmholtzzentrum für Schwerionenforschung
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Work supported by HGS-HIRE for FAIR